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BY: Warmy Will

Date: April 26, 2002

7/A 5/14/02 Awali

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Heinrich Brunner et al.

Applic. No.

: 09/816,927

Filed

: March 23, 2001

Title

: Semiconductor Component Having Field-Shaping

Regions

Examiner

: Kiesha L. Rose

Group Art Unit: 2822

## AMENDMENT

Hon. Commissioner of Patents and Trademarks, Washington, D. C. 20231

Sir:

Responsive to the non-final Office action dated January 30, 2002, kindly amend the above-identified application as follows:

In the Specification:

Replace the paragraph on page 1, lines 6-8, with --

This application is a continuation of copending International Application No. PCT/DE99/02732, filed September 1, 1999, which